# MCS-4 MICRO COMPUTER SET

**APRIL 1972** 

- Microprogrammable General Purpose Computer Set
- 4-Bit Parallel CPU With 45 Instructions
- Instruction Set Includes
   Conditional Branching, Jump to
   Subroutine and Indirect Fetching
- Binary and Decimal Arithmetic Modes
- Addition of Two 8-Digit Numbers in 850 Microseconds
- **2-Phase Dynamic Operation**

- 10.8 Microsecond Instruction Cycle
- CPU Directly Compatible With MCS-4 ROMs and RAMs
- Easy Expansion—One CPU can
  Directly Drive up to 32,768
  Bits of ROM and up to 5120
  Bits of RAM
- Unlimited Number of Output Lines
- Packaged in 16-Pin Dual In-Line Configuration

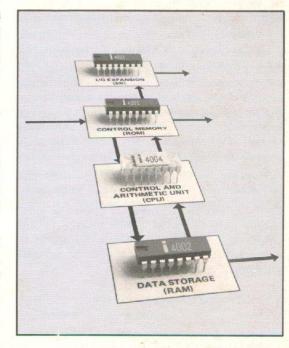
The MCS-4 is a microprogrammable computer set designed for applications such as test systems, peripherals, terminals, billing machines, measuring systems, numeric and process control. The 4004 CPU, 4003 SR, and 4002 RAM are standard building blocks. The 4001 ROM contains the custom microprogram and is implemented using a metal mask according to customer specifications.

MCS-4 systems interface easily with switches, keyboards, displays, teletypewriters, printers, readers, A-D converters and other popular peripherals.

A system built with the MCS-4 micro computer set can have up to  $4K \times 8$  bit ROM words,  $1280 \times 4$  bit RAM characters and 128 I/O lines without requiring any interface logic. By adding a few simple gates the MCS-4 can have up to 48 RAM and ROM packages in any combination, and 192 I/O lines. The minimum system configuration consists of one CPU and one  $256 \times 8$  bit ROM.

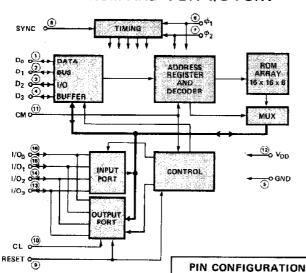
The MCS-4 has a very powerful instruction set that allows both binary and decimal arithmetic. It includes conditional branching, jump to subroutine, and provides for the efficient use of ROM look-up tables by indirect fetching.

The Intel MCS-4 micro computer set (4001/2/3/4) is fabricated with Silicon Gate Technology. This low threshold technology allows the design and production of higher performance MOS circuits and provides a higher functional density on a monolithic chip than conventional MOS technologies.



# MCS·4<sup>™</sup>Description

#### 256 x 8 BIT MASK PROGRAMMABLE 4001 ROM AND 4 BIT I/O PORT



The 4001 is a 2048-bit metal mask programmable ROM providing custom microprogramming capability for the MCS-4 micro computer set. It is organized as 256 x 8 bit words.

Address and data are transferred in and out by time multiplexing on 4 data bus lines. Timing is internally generated using two clock signals,  $\phi_1$  and  $\phi_2$ , and a SYNC signal supplied by the 4004. Addresses are received from the CPU on three time periods following SYNC, and select 1 out of 256 words and 1 out of 16 ROM's. For that purpose, each ROM is identified as #0, 1, 2, through 15, by metal option. A Command Line (CM) is also provided and its scope is to select a ROM bank (group of 16 ROM's).

PHASE 1 1

CLOCK 02 PHASE 2

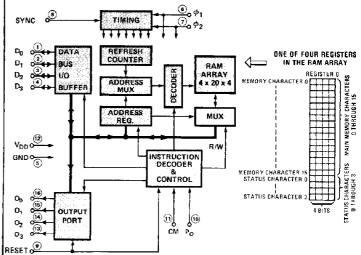
SYNC SYNC

During the two time periods (M<sub>1</sub> & M<sub>2</sub>) following the addressing time, information is transferred from the ROM to the data bus lines.

A second mode of operation of the ROM is as an Input/Output control device. In that mode a ROM chip will route information to and from data bus lines in and out of 4 I/O external lines. Each chip has the capability to identify itself for an I/O port operation, recognize an I/O port instruction and decide whether it is an Input or an Output operation and execute the instruction. An external signal (CL) will asynchronously clear the output register during normal operation. All internal flip flops (including the output register) will be reset when the RESET line goes low (negative voltage).

Each I/O pin can be uniquely chosen as either an input or output port by metal option. Direct or inverted input or output is optional. An on-chip resistor at the input pins, connected to either  $V_{\mbox{\scriptsize DD}}$  or  $V_{\mbox{\scriptsize SS}}$  is also optional. (See ordering information on page 12).

#### 4002 320 BIT RAM AND 4 BIT OUTPUT PORT



The 4002 performs two functions. As a RAM it stores 320 bits arranged in 4 registers of twenty 4-bit characters each (16 main memory characters and 4 status characters). As a vehicle of communication with peripheral devices, it is provided with 4 output lines and associated control logic to perform output operations.

14 1/02 LINES

CM CONTROL

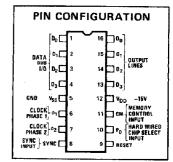
10 CL CLEAR IMPUT

15 🔲 1/0,

13 🗀 1/03

J 400

RESET



In the RAM mode, the operation is as follows: When the CPU executes an SRC instruction (see Instruction Set on page 5) it will send out the contents of the designated index register pair during  $X_2$  and  $X_3$  as an address to the RAM, and will activate one CM-RAM line at X2 for the previously (Note 1) selected RAM bank (see Basic Instruction Cycle on page 5).

The data at  $X_2$  and  $X_3$  is interpreted as shown below:

X	X3					
D <sub>3</sub> D <sub>2</sub> Ghip #	D <sub>1</sub> Regis	D <sub>O</sub> ter #	D <sub>3</sub> Main i	D <sub>2</sub> Viemory	D <sub>1</sub> Characte	D <sub>0</sub>
(0 through 3)	(0 thr	ough 3)	1		ugh 15)	

The status character locations (0 through 3) are selected by the OPA portion of one of the I/O and RAM Instructions. For chip selection, the 4002 is available in two metal options, 4002-1 and 4002-2. An external pin, Po (which may be hard wired to either VDD or VSS) is also available for chip selection. The chip number is assigned as follows:

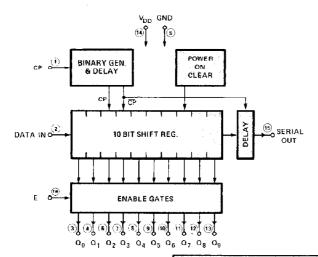
Chip #	4002 Option	Po	D <sub>3</sub>	$D_2$	@ X <sub>2</sub>
0	4002-1	GND	0	0	
1	4002-1	V <sub>DD</sub>	0	- 1	
2	4002-2	GND	1	0	
3	4002-2	VDD	1	1	

Timing is internally generated using two clock signals,  $\phi_1$  and  $\phi_2$ , and a sync signal provided by the 4004. Internal refresh circuitry maintains data levels in the cells.

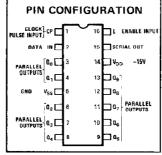
All communications with the system is through the data bus. The I/O port permits data out from the system. When the external RESET signal goes low, the memory and all static flip-flops (including the output registers) will be cleared. To fully clear the memory the RESET signal must be maintained for at least 32 memory cycles (32 x 8 clock periods).

# MCS-4<sup>™</sup> Description

# 4003 10 BIT SERIAL-IN/PARALLEL-OUT, SERIAL-OUT SHIFT REGISTER (SR)



The 4003 is a 10 bit static shift register with serial-in, parallelout and serial-out data. Its function is to increase the number of output lines to interface with I/O devices such as keyboards, displays, printers, teletypewriters, switches, readers, A-D converters, etc.



Data is loaded serially and is available in parallel on 10 output lines which are accessed through enable logic. When enabled (E = low), the shift register contents is read out; when not enabled (E = high), the parallel-out lines are at  $V_{SS}$ . The serial-out line is not affected by the enable logic.

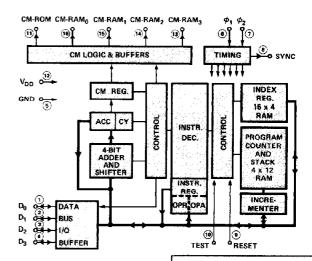
Data is also available serially permitting an indefinite number of similar devices to be cascaded together to provide shift register length multiples of 10.

The data shifting is controlled by the CP signal. An internal power-on-clear circuit will clear the shift register ( $Q_i = V_{SS}$ ) between the application of the supply voltage and the first CP signal.

#### 4002 320 BIT RAM AND 4 BIT OUTPUT PORT

NOTE 1: Bank switching is accomplished by the CPU after receiving a "DCL" (designate command line) instruction. Prior to execution of the DCL instruction the desired CM-RAM; code has been stored in the accumulator (for example through an LDM instruction). During DCL the CM-RAM; code is transferred from the accumulator to the CM-RAM register. The RAM bank is then selected starting with the next instruction.

# 4004 4 BIT CENTRAL PROCESSOR UNIT (CPU) WITH 45 INSTRUCTIONS



The 4004 is a central processor unit (CPU) designed to work in conjunction with the other members of the MCS-4 (4001, 4002, 4003) for microprogrammable computer applications.

PIN CONFIGURATION

| Data | Da

The CPU chip consists of a 4 bit adder, a 64 bit (16 x 4) index

register, a 48 bit (4 x 12) program counter and stack (nesting up to three levels is possible), an address incrementer, an 8 bit instruction register and decoder, and control logic. Information flows between the 4004 and the other chips through a 4-line data bus. One 4004 may be combined with up to 48 ROM (4001) and RAM (4002) chips in any combination.

A typical machine cycle starts with the CPU sending a synchronization signal (SYNC) to the ROM's and RAM's. Next, 12 bits of ROM address are sent to the data bus using three clock cycles (@ .75 MHz). The address is then incremented by one and stored in the program counter. The selected ROM sends back 8 bits of instruction or data during the following 2 clock cycles. This information is stored in two registers: OPR and OPA. The next three clock cycles are used to execute the instruction. (See Basic Instruction Cycle on page 5.)

The ROM bank is controlled by a command ROM control signal (CM-ROM) and up to four RAM banks are controlled by four command RAM control signals (CM-RAM<sub>0</sub>, CM-RAM<sub>1</sub>, CM-RAM<sub>2</sub>, CM-RAM<sub>3</sub>). Bank switching is accomplished by the execution of the DCL instruction (see Note 1 this page).

An input test signal (TEST) is used in conjunction with the jump on condition (JCN) instruction. An external RESET signal is used to clear all registers and flip-flops. To fully clear all registers, the RESET signal must be applied for at least 8 instruction cycles (8 x 8 clock periods). After RESET the program will start from "0" step and CM-RAM<sub>0</sub> will be selected.

The instruction repertoire of the 4004 consists of:

- (a) 16 machine instructions (5 of which are double length).
- (b) 14 accumulator group instructions.
  - ) 15 input/output & RAM instructions.

# MCS-4<sup>™</sup>Operation

The detailed functional specifications describing the operation of the system, the instruction set, the activity of the CPU for each instruction and some programming and hardware examples are published separately and are available upon request. Following is a brief outline of the system operation.

The MCS-4 uses a 10.8  $\mu$ sec instruction cycle. The CPU (4004) generates a synchronizing signal (SYNC), indicating the start of an instruction cycle, and sends it to the ROM's (4001) and RAM's (4002).

Basic instruction execution requires 8 or 16 cycles of a 750 KHz clock. In a typical sequence, the CPU sends 12 bits of address to the ROM's in the first three cycles  $(A_1, A_2, A_3)$ . The selected ROM chip sends back 8 bits of instruction (OPR, OPA) to the CPU in the next two cycles  $(M_1, M_2)$ . The instruction is then interpreted and executed in the final three cycles  $(X_1, X_2, X_3)$ . (See Figure 2.)

The CPU, RAM's and ROM's can be controlled by an external RESET line. While RESET is activated the contents of the registers and flip-flops are cleared. After RESET, the CPU will start from address 0 and CM-RAM<sub>0</sub> is selected.

The MCS-4 can have up to 4K x 8 bit ROM words, 1280 x 4 bit RAM characters and 128 I/O lines, without requiring any interface logic. By adding a few simple gates, the MCS-4 can have up to 48 RAM and ROM packages in any combination and 192 I/O lines.

The 4001, 4002, and 4004 are interconnected by a 4-line data bus  $(D_0, D_1, D_2, D_3)$ , used for all information flow between the chips except for control signals sent by the CPU on 6 additional lines. The interconnection of the MCS-4 system is shown in Figure 1. An expanded configuration is shown. The mannage of the control of the MCS-4 system is shown in (4001). Figure 2 shows the activity on the data bus during each clock period, and how a basic instruction cycle is subdivided.

Each data bus output buffer has three possible states "1", "0", and floating. At a given time only one output buffer is allowed to drive a data line, therefore, all the other buffers must be in a floating condition. However, more than one input buffer per data line can receive data at the same time.

The MCS-4 has a very powerful Instruction Set that allows both binary and decimal arithmetic. It includes conditional branching, jump to subroutine and provides for the efficient use of ROM look up tables by indirect fetching. Typically, two 8 digit numbers can be added in 850 µsec. The complete Instruction Set is shown on pages 5 and 6.

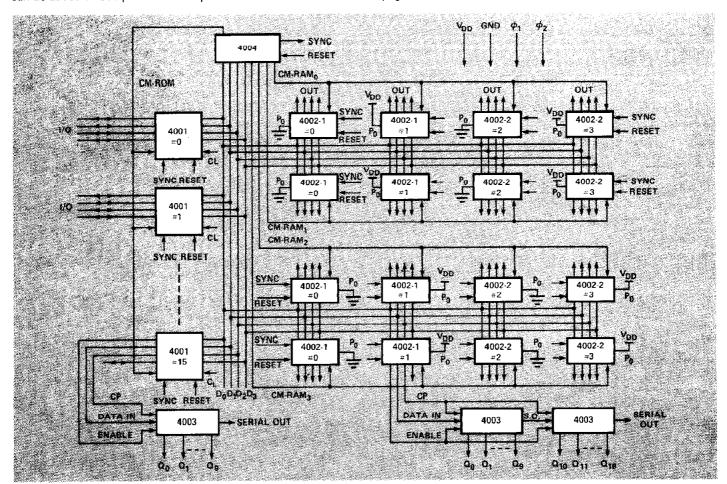
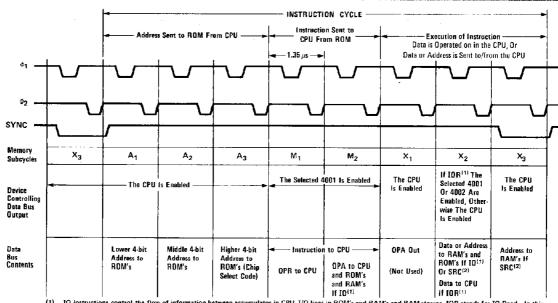


Figure 1. MCS-4 System Interconnection

# MCS-4 Operation



<sup>1)</sup> IO instructions control the flow of information between accumulator in CPU, I/O lines in ROM's and RAM's and RAM storage. IOR stands for IO Read. In this case the CPU will receive data from RAM storage locations or I/O input lines of 4001's.

Figure 2. MCS-4 Basic Instruction Cycle

### Instruction Set

[Those instructions preceded by an asterisk (\*) are 2 word instructions that occupy 2 successive locations in ROM] MACHINE INSTRUCTIONS

MNEMONIC	OPR D3 D2 D1 D0	OPA D <sub>3</sub> D <sub>2</sub> D <sub>1</sub> D <sub>0</sub>	DESCRIPTION OF OPERATION
NOP	0000	0 0 0 0	No operation,
*JCN	0 0 0 1 A <sub>2</sub> A <sub>2</sub> A <sub>2</sub> A <sub>2</sub>	C <sub>1</sub> C <sub>2</sub> C <sub>3</sub> C <sub>4</sub> A <sub>1</sub> A <sub>1</sub> A <sub>1</sub> A <sub>1</sub>	Jump to ROM address A <sub>2</sub> A <sub>2</sub> A <sub>2</sub> A <sub>3</sub> A <sub>1</sub> A <sub>1</sub> A <sub>1</sub> A <sub>1</sub> A <sub>1</sub> (within the same ROM that contains this JCN instruction) if condition C <sub>1</sub> C <sub>2</sub> C <sub>3</sub> C <sub>4</sub> (1), is true, otherwise skip (go to the next instruction in sequence).
*FIM	0 0 1 0 D <sub>2</sub> D <sub>2</sub> D <sub>2</sub> D <sub>2</sub>	B R R 0 D <sub>1</sub> D <sub>1</sub> D <sub>1</sub> D <sub>1</sub>	Fetch immediate (direct) from ROM Data D <sub>2</sub> , D <sub>1</sub> to index register pair location RRR. <sup>(2)</sup>
SRC	0010	RRR1	Send register control. Send the address (contents of index register pair RRR) to ROM and RAM at $X_2$ and $X_3$ time in the instruction Cycle.
FIN	0 0 1 1	PRRO	Fetch Indirect from ROM, Send contents of index register pair location 0 out as an address, Data fetched is placed into register pair location RRR.
. Wit.	0011	RRR1	Jump Indirect, Send contents of register pair RRR out as an address at A <sub>1</sub> and A <sub>2</sub> time in the Instruction Cycle.
*JUN	0 1 0 0 A <sub>2</sub> A <sub>2</sub> A <sub>2</sub> A <sub>2</sub>	A <sub>3</sub> A <sub>3</sub> A <sub>3</sub> A <sub>3</sub> A <sub>1</sub> A <sub>1</sub> A <sub>1</sub> A <sub>1</sub>	Jump unconditional to ROM address A3, A2, A1.
*JMS	0 1 0 1 A <sub>2</sub> A <sub>2</sub> A <sub>2</sub> A <sub>2</sub>	A3 A3 A3 A3 A1 A1 A1 A1	Jump to subroutine ROM address A <sub>3</sub> , A <sub>2</sub> , A <sub>1</sub> , save old address, (Up 1 level in stack.)
INC	0110	AAAR	Increment contents of register RRRR. (3)
*16Z	0 1 1 1 A <sub>2</sub> A <sub>2</sub> A <sub>2</sub> A <sub>2</sub>	A R R A A <sub>1</sub> A <sub>1</sub> A <sub>1</sub>	Increment contents of register RRRR. Go to ROM address A2. A1 (within the same ROM that contains this ISZ Instruction) If result ≠0, otherwise skip (go to the next instruction in sequence);
ADD	1000	RRRR	Add contents of register RRRR to accumulator with carry.
sue .	1001	RRRR	Subtract contents of register RRRR to accumulator with borrow.
LD	1010	RRRR	Load contents of register RRRR to accumulator.
XCH .	1:011	BARR	Exchange contents of Index register ARRR and accumulator.
BBL	1 1 0 0	DDDD	Branch back (down 1 level in stack) and load data DDDD to accumulator.
LOM	1101	DODD	Load data DDDD to accumulator:

See Notes on Page 6.

Continued on page 6.

<sup>2)</sup> The SRC instruction designates the chip number and address for a following IO instruction.

### Instruction Set

### INPUT/OUTPUT AND RAM INSTRUCTIONS

(The RAM's and ROM's operated on in the I/O and RAM instructions have been previously selected by the last SRC instruction executed.)

MNEMONIC	0PR 03020100	0PA D <sub>3</sub> D <sub>2</sub> D <sub>1</sub> D <sub>0</sub>	DESCRIPTION OF OPERATION
WRM	1 1 1 0	0 0 0 0	Write the contents of the accumulator into the previously selected RAM main memory character.
WMP .	1 1 1 0	0.001	Write the contents of the accumulator into the previously selected RAM output port. (Output Lines)
WRR	1 1 1 0	0 0 1 0	Write the contents of the accumulator into the previously selected ROM output port. (I/O Lines)
; wro <sup>(4)</sup>	1 1 1 0	0 1 6 0	Write the contents of the accumulator into the previously selected RAM status character 0.
WR1 <sup>(4)</sup>	1 1 1 0	0 1 0 1	Write the contents of the accumulator into the previously selected RAM status character 1.
WR2(4)	1110	0 1 1 0	Write the contents of the accumulator into the previously selected RAM status character 2,
wяз <sup>(4)</sup>	1 1 1 0	0 1 1 1	Write the contents of the accumulator into the previously selected RAM status character 3.
SBM	1110	1000	Subtract the previously selected RAM main memory character from accumulator with borrow.
RDM	1 1 1 0	1 0 0 1	Read the previously selected RAM main memory character into the accumulator.
ADA:	1110	1 0 1 0	Read the contents of the previously selected ROM input port into the accumulator. (I/O Lines)
ADM	1 1 1 0	1011	Add the previously selected RAM main memory character to accumulator with carry.
πρφ <sup>(4)</sup>	1 1 1 0	1 1 0 0	Read the previously selected RAM status character 0 into accumulator.
RD1 <sup>(4)</sup>	1 1 1 0	1 1 0 1	Read the previously selected RAM status character 1 into accumulator.
RD2 <sup>(4)</sup>	1, 1, 1, 0	1 1 1 0	Read the previously selected RAM status character 2 into accumulator.
RD3 <sup>(4)</sup>	1 1 1 0	1 1 1 1	Read the previously selected RAM status character 3 into accumulator.

#### **ACCUMULATOR GROUP INSTRUCTIONS**

CLa	1 1 1 1	0 0 0 0	Clear both, (Accumulator and carry)
CLC	1 1 1 1	0 0 0 1	Clear carry.
IAC	1111	0 0 1 0	Increment accumulator
СМС	1 1 1 1	0 0 1 1	Complement carry,
CMA	1111	0 1 0 0	Complement accumulator.
RAL	1 1 1 1	0 1 0 1	Rotate left. (Accumulator and carry)
RAB	1111	0110	Rotate right. (Accumulator and carry)
TEC	1 1 1 1	0 1 1 1	Transmit carry to accumulator and clear carry.
DAC	Pr - 1, 1 1 1	1000	Decrement accumulator.
тсѕ	1111	1 0 0 1	Transfer carry subtract and clear carry.
src	1.1111	1010	Set carry.
DAA		1011	Decimal adjust accumulator.
K8P	1.1.1.1	1 1 0 0	Keyboard process. Converts the contents of the accumulator from a one out of four code to a binary code.
DCL		1 1 0 1	Designate command line. (See note 1 on page 3,)

NOTES: (1) The condition code is assigned as follows:

 $C_1 = 1$  Invert jump condition  $C_2 = 1$  Jump if accumulator is zero  $C_4 = 1$  Jump if test signal is a 0  $C_1 = 0$  Not invert jump condition  $C_3 = 1$  Jump if carry/link is a 1

(2) RRR is the address of 1 of 8 index register pairs in the CPU.

(3) RRRR is the address of 1 of 16 index registers in the CPU.

<sup>(4)</sup> Each RAM chip has 4 registers, each with twenty 4-bit characters subdivided into 16 main memory characters and 4 status characters. Chip number, RAM register and main memory character are addressed by an SRC instruction. For the selected chip and register, however, status character locations are selected by the instruction code (OPA).

# **Absolute Maximum Ratings\***

Ambient Temperature Under Bias	0°C to +70°C
Storage Temperature	-55°C to +150°C
Input Voltages and Supply Voltage	
With Respect to V <sub>SS</sub>	+0.5 to20V
Power Dissipation	1.0 W

#### \*COMMENT

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other condition above those indicated in the operational sections of this specification is not implied.

# D.C. and Operating Characteristics

 $T_A = 0^{O}C$  to  $+70^{O}C$ ;  $V_{DD} = -15V \pm 5\%$ ,  $V_{SS} = GND$ ,  $t_{\phi PW} = t_{\phi D1} = 400$  nsec,  $t_{\phi D2} = 150$  nsec, unless otherwise specified Logic "0" is defined as the more positive voltage ( $V_{1H}$ ,  $V_{OH}$ ), Logic "1" is defined as the more negative voltage ( $V_{1L}$ ,  $V_{OL}$ )

#### SUPPLY CURRENT

PRODUCT *	' SYMBOL	PARAMETER	LIMI MIN: TYP	22.2000 (0.000)	UNIT	TEST CONDITIONS
4001	l <sub>DD1</sub>	AVERAGE SUPPLY CURRENT	15	30	mA	T <sub>A</sub> = 25°C
4002	loo2	AVERAGE SUPPLY CURRENT	17	33	mA	T <sub>A</sub> = 25°C
4003	l <sub>DD3</sub>	AVERAGE SUPPLY CURRENT	5.0	8.5	mA	t <sub>WL</sub> = t <sub>WH</sub> = 8 µsec; T <sub>A</sub> = 25°C
4004	'DD4	AVERAGE SUPPLY CUBRENT	30	a 40	m/A.	TA = 26°C

#### INPUT CHARACTERISTICS (ALL INPUTS EXCEPT I/O INPUT PINS)

4001/2/4	L L	INPUT LEAKAGE CURRENT		10	μΑ	V <sub>IL</sub> =V <sub>00</sub>
4001/2/4	V <sub>IH</sub>	INPUT HIGH VOLTAGE (EXCEPT CLOCKS)	V <sub>SS</sub> -1,5	V <sub>SS</sub> +0.3	٧	
4001/2/4	YIL	INPUT LOW VOLTAGE (EXCEPT CLOCKS)	Vpp .	V <sub>98</sub> -5.5	٧ -	
4001/2/4	VILC	CLOCK INPUT LOW VOLTAGE	V <sub>DD</sub>	V <sub>SS</sub> -13.4	V	
4901/2/4	Уінс	CLOCK INPUT HIGH VOLTAGE	V <sub>SS</sub> -1.5	V88+0.3	٧	

#### **OUTPUT CHARACTERISTICS (ALL OUTPUTS EXCEPT I/O OUTPUT PINS)**

4001/2/4	'uo	DATA BUS OUTPUT LEAKAGE CURRENT			10	μА	V <sub>OUT</sub> + -12V, Chin disabled
4001/2/4	v <sub>oн</sub>	OUTPUT HIGH VOLTAGE		∨ <sub>55</sub>	V <sub>SS</sub> -0.5	٧	Driving 4000 Series loads only
4001/2/4	loa	DATA LINES SINKING CURRENT "1" LEVEL	10	18	esater House	mA.	VOUT ***
4004	I <sub>OL5</sub>	CM-ROM SINKING CURRENT "1" LEVEL	6,5	12		mA	V <sub>OUT</sub> = 0V
4004	lore	CM-RAM LINES SINKING CURRENT "1" LEVEL	2.5	4		mA	Voint # 0V
4001/2/4	V <sub>OL1</sub>	DATA LINES, CM LINES, SYNC OUTPUT LOW VOLTAGE	Vss-12	V <sub>SS</sub> -10	V <sub>SS</sub> -6.5	ν	1 <sub>OL1</sub> = 500 μA
4001/2/4	<sup>8</sup> он1	OUTPUT RESISTANCE DATA LINES "O" LEVEL		150	260	Ω	Vout ==0.8V
4004	R <sub>OH5</sub>	CM-ROM OUTPUT RESISTANCE "0" LEVEL		320	600	Ω	V <sub>OUT</sub> = -0.5V
4004	<sup>В</sup> оне	CM-RAM LINES OUTPUT RESISTANCE "O" LEVEL		1,1	1.8	ĸΩ	V <sub>OUT</sub> ==0.5V sa

#### I/O INPUT CHARACTERISTICS

40	01		1/O FINS INPUT RESISTANCE	10	18	35	KΩ	Internal input resistor is optional
40	01	Ð	I/O PINS INPUT RESISTANCE	40	40	00	40	
40	01/3	ارا <mark>ل (2)</mark>	INPUT LOW VOLTAGE	VDD		VSS-4.2	٧.	
40	01/3	V <sub>IH</sub>	INPUT HIGH VOLTAGE	V <sub>SS</sub> -1.5	5	V <sub>SS</sub> +0.3		
	01/3	14	INPUT LEAKAGE CURRENT			10	μA	VIL + VDD

#### I/O OUTPUT CHARACTERISTICS

4001/2	'QL2	I/O OUTPUT LINES SINKING CURRENT, "I" LEVEL	72.5 5	mA.	YOUT -DV. Far T2L pompatibility a: 12KΩ (±10%) reserve between put- purand Vop; should be added \$3.
4003	OL3	PARALLEL OUT PINS SINKING CURRENT, "1" LEVEL	0.6 1.0	mA	VOUT = 0V. For $T^2L$ compatibility a 5.6K $\Omega$ ( $\pm$ 10%) resistor between output and $V_{DD}$ should be added <sup>(3)</sup> .
4003	loL4	SERIAL OUT SINKING	1.0 2.0	mA	Your -ove
4001/2	V <sub>OL2</sub>	I/O OUTPUT LINES OUTPUT LOW VOLTAGE	V <sub>SS</sub> -12 V <sub>SS</sub> -7.5 V	∨ <sub>SS</sub> -6.5 ∨	1 <sub>OL2</sub> = 50µA
4003	V <sub>OL3</sub>	OUTPUT LOW VOLTAGE	Vss11 Vss7.5 \	/85-6.8 V	I <sub>111.3</sub> = 10 pak
4001/2	R <sub>OH2</sub>	OUTPUT RESISTANCE I/O LINES "O" LEVEL	1.2	1.8 ΚΩ	V <sub>OUT</sub> = -0.5V
4003	<sup>В</sup> онз	PARALLEL-OUT PINS OUTPUT RESISTANCE "O" LEVEL	400	780 Ω	Your *-asv
4003	R <sub>OH4</sub>	SERIAL OUT OUTPUT RESISTANCE "0" LEVEL	650	1200 Ω	V <sub>OUT</sub> = -0.5V

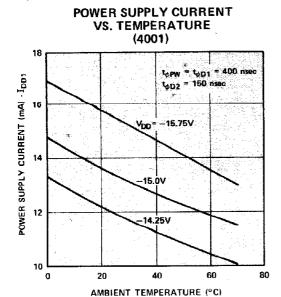
<sup>(1)</sup> Typical values are for T<sub>A</sub> = 25°C and Nominal Supply Voltages.

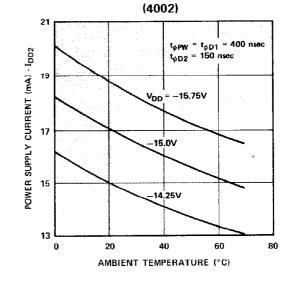
<sup>(3)</sup> For T<sup>2</sup>L compatibility on the I/O lines the supply voltages should be

<sup>(2)</sup> If non-inverting input option is used,  $V_{IL}$  = -6.5 Volts maximum.

 $V_{DD} = -10V \pm 5\%$   $V_{SS} = +5V \pm 5\%$ 

# Typical D.C. Characteristics

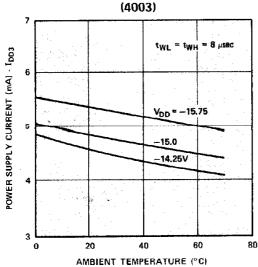


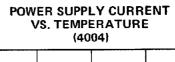


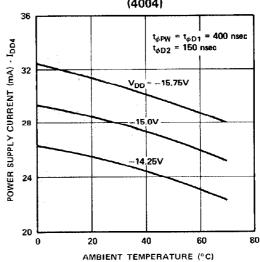
POWER SUPPLY CURRENT

**VS. TEMPERATURE** 

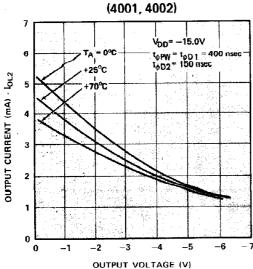




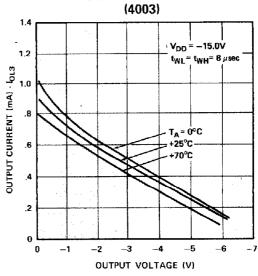




#### OUTPUT CURRENT VS. OUTPUT VOLTAGE (4001 4002)



# OUTPUT CURRENT VS. OUTPUT VOLTAGE (4003)



# 4001, 4002, 4004 A.C. Characteristics

 $T_A$  = 0°C to +70°C;  $V_{DD}$  =  $-15V \pm 5\%$ ,  $V_{SS}$  = GND

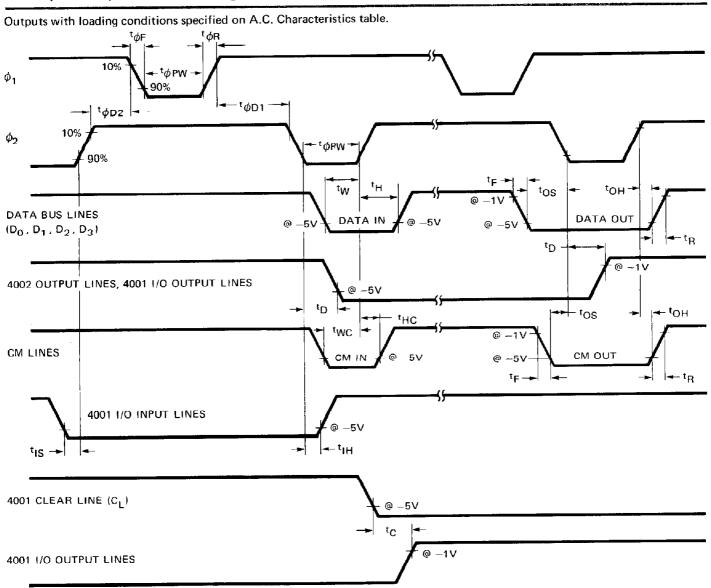
PRODUCT	SYMBOL	TEST	LIMIT MIN. MAX.	UNIT	CONDITIONS
4001/2/4	t <sub>φR</sub> t <sub>φF</sub>	CLOCK RISE AND FALL TIMES	10 50	nsec	
	$t_{\phi_PW}$	CLOCK WIDTH	380 480	nsec	
	t <sub>øD1</sub>	CLOCK DELAY FROM φ <sub>1</sub> TO φ <sub>2</sub>	400 550	nsec	
	t <sub>φD2</sub>	CLOCK DELAY FROM $\phi_2$ TO $\phi_1$	150 300	nsec	
	<sup>t</sup> w	DATA-IN WRITE TIME	350	nsec	
	t <sub>H</sub>	DATA-IN HOLD TIME	40	nsec	
	t <sub>os</sub> <sup>(1)</sup>	SET TIME FOR DATA OUT, SYNC, CM-ROM, (2) CM- RAM, (2) LINES	0	nsec	C <sub>OUT</sub> = 500 pF for data lines 500 pF for SYNC 160 pF for CM-ROM 50 pF for CM-RAM
	t <sub>OH</sub>	HOLD TIME FOR DATA OUT, SYNC, . CM-ROM, CM-RAM; LINES	50	nsec	C <sub>OUT</sub> = 20 pF
	t <sub>R</sub> ,t <sub>F</sub>	RISE AND FALL TIMES FOR DATA OUT, SYNC, CM-ROM, CM-RAM; LINES	500	nsec	C <sub>OUT</sub> = 500 pF for data lines 500 pF for SYNC 160 pF for CM-ROM 50 pF for CM-RAM
4001/2	<b>t</b> D	I/O OUTPUT LINES DELAY	600	nsec	С <sub>оит</sub> = 20 pF
	t <sub>WC</sub>	CM WRITE TIME	350	nsec	
	t <sub>HC</sub>	CM HOLD TIME	10	nsec	
4001	† <sub>is</sub>	I/O INPUT LINES SET TIME	50	nsec.	
	t <sub>in</sub>	I/O INPUT LINES HOLD TIME	100	nsec	72 (A) (B) (B)
	t <sub>6</sub> (3)	I/O OUTPUT LINES DELAY ON CLEAR	200	risec	C <sub>OUT</sub> = 20 pF

NOTES: (1)Data out, SYNC, CM-ROM, and CM-RAM; lines are clocked out with the trailing edge of the  $\phi_2$  clock.

<sup>(2)</sup> The CM-ROM and the selected CM-RAM; lines are always activated during A<sub>3</sub> time. They are also activated during M<sub>2</sub> time if an I/O and RAM instruction was fetched by the CPU, and during X<sub>2</sub> time if an SRC instruction was fetched by the CPU.

<sup>(3)</sup> Pin  $C_L$  on 4001 is used to asynchronously clear the output flip-flops associated with the I/O lines.

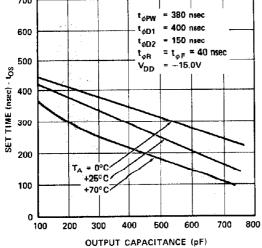
### 4001, 4002, 4004 Timing Diagram



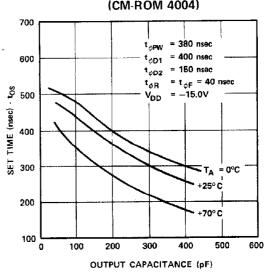
# **Typical Load Characteristics**

(DATA LINES FOR 4001, 4002, 4004 & SYNC FOR 4004) 700 = 380 nsec = 400 nsec  $t_{\phi D1}$ = 150 nsec t<sub>ØD2</sub> =  $t_{\phi F}$  = 40 nsec ŧφR

SET TIME VS. OUTPUT CAPACITANCE



SET TIME VS. OUTPUT CAPACITANCE (CM-ROM 4004)



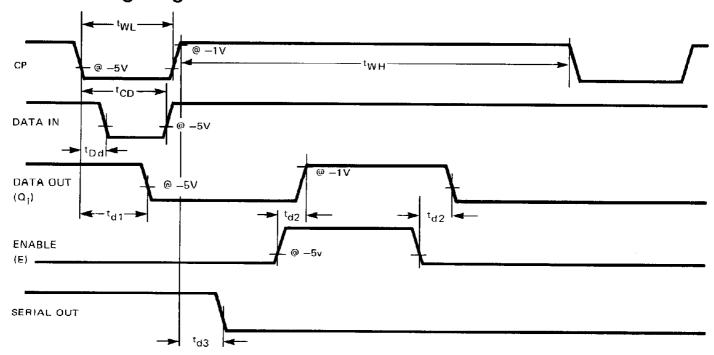
# 4003 A.C. Characteristics

 $T_A = 0^{\circ}C$  to +70°C;  $V_{DD} = -15 \pm 5\%$ ,  $V_{SS} = GND$ 

	· ·	LIMIT			
SYMBOL *	TEST	MIN.	MAX.	UNIT	CONDITIONS
<sup>t</sup> WL	CP LOW WIDTH	6	10,000	μsec	
<b>'</b> W+1	CP HIGH WIDTH	6	Note (1)	(isec	
t <sub>CD</sub>	CLOCK-ON TO DATA-OFF TIME	3		μsec	
¹bd ⊹	CP TO DATA SET DELAY	Note (2) *	250	nsec	
<sup>†</sup> d1	CP TO DATA OUT DELAY	250	1,750	nsec	
<b>G</b> 12	ENABLE TO DATA OUT DELAY		350	nsec	COUT = 20 pF
t <sub>d</sub> 3	CP TO SERIAL OUT DELAY	200	1,250	nsec	C <sub>OUT</sub> = 20 pF

NOTES: (1) $_{\rm tWH}$  can be any time greater than 6  $\mu$  sec. (2)Data can occur prior to CP.

### 4003 Timing Diagram



# Capacitance

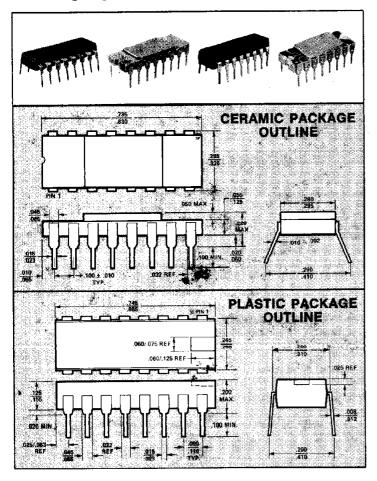
f = 1 MHz;  $V_{IN} = 0 \text{ V}$ ;  $T_A = 25^{\circ} \text{ C}$  ; Unmeasured Pins Grounded.

			LIMIT (pF)	
PRODUCT	SYMBOL	TEST	TYP.	MAX.
4001/2/3/4	C <sub>IN</sub>	INPUT (1) CAPACITANCE	5	10
4001/2	$c_{\phi 1}, c_{\phi 2}$	CLOCK INPUT CAPACITANCE	8	15
4004	$c_{\phi 1}, c_{\phi 2}$	CLOCK INPUT CAPACITANCE	14	20

				LIMIT (pF)	
0.000	PRODUCT	SYMBOL	TEST	TVP.	MAX:
	4002/4	C <sub>D1</sub>	DATA BUS. I/O LINES CAPACITANCE	6.5	10
	4001	C <sub>D2</sub>	DATA BUS I/O LINES CAPACITANCE	9.5	15

NOTE: (1) Refers to all input pins except data bus I/O and  $\phi_1$  and  $\phi_2$ .

### **Packaging Information**



### **Ordering Information**

- The 4004 (CPU) is available in ceramic only and should be ordered as C4004.
- (2) The 4001 (ROM), 4002 (RAM) and 4003 (SR) are presently available off the shelf in plastic only. These devices can be ordered in ceramic on special request. Standard devices should be ordered as follows:

P4001 Plastic Package

- P4002-1 (Metal Option #1) Plastic Package
- P4002-2 (Metal Option #2) Plastic Package P4003 Plastic Package

#### (3) Mask Programming of the 4001

The custom patterns, chip numbers and I/O options (including inverting and non-inverting inputs or outputs and on-chip resistor connected to either VDD or VSS) must be specified on a truth table for each 4001 ordered. Blank custom truth tables are available upon request from Intel.

- (4) MCS-4 Evaluation Kit Using the 4001-0009 ROM This kit provides a convenient way of evaluating the MCS-4 parts, Using the microprogram stored in the 4001-0009, all of the 45 instructions of the MCS-4 instruction set are executed. This kit is made up of one 4004, one 4001-0009, and two
- This kit is made up of one 4004, one 4001-0009, and two 4002-1's. To order, specify the individual part numbers.

  SIM4-01: Prototyping System

  An interface board in which 1701 or 1702 electrically pro-

grammable and erasable ROM's simulate the 4001 mask programmable ROM's provides a design tool for developing a system. This board contains one 4004, four 4002's and has provision for up to four 1701's or 1702's. The board should be ordered as SIM4-01 (the type and number of PROM's should also be indicated).

(6) SIM4-02: Prototyping System

This board is an expanded version of the SIM4-01. It contains one 4004, four 4002's, and has provision for an additional twelve 4002's and sixteen 1701's or 1702's. The board should be ordered as SIM4-02 (the type and number of PROM's and RAM's should also be indicated).

(7) MP7-02 ROM Programmer

This is the programmer board for 1601/1701 or 1602/1702. The three 1602 control ROM's used with the SIM4 cards for an automatic programming system are specified by pattern numbers A0540, A0541, A0542. All items should be ordered individually.

(8) PROM Program A0700: Sample Decimal Addition Program The SIM4-01 or SIM4-02 systems (interfaced with TTY) can be checked out using this special program in a 1701 or 1702. When ordering PROM's, specify one of the devices programmed to Intel tape number A0700.

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